ASDCIATION CONNECTING ELECTRONICS (MOUSTRIES*) MOUSTRIES*	ourn. Illinois. All rights reserved	under both This docur level parts.	nent is a declarati the declaration e	on of the substance ncompasses all lov	es within the manufactur wer level materials for w	er listed item. Note hich the manufactu	e: if the item is an as irer has engineering	ssembly with lower responsibility.	
IPC Web Site for Information on I   http://www.ipc.org/IPC-175x	r Information on IPC-1752 Standard Form Type * Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					
Supplier Information									
Company name*	Company unique ID		Unique ID Authority			Response Date*			
onsemi						2024-04-24			
Contact Name	Title - Contact		Phone - Contact*			Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance		NA			Product-Env-Stewards@onsemi.com			
Authorized Representative*	Title - Representative		Phone - Representative*			Email - Representative*			
Product-Env-Stewards Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Item	n Number Mfr Item Name	Mfr Item Name		Version	Manufacturing Site	Weight*	UOM	Unit Type	
NCV705 G	516MW1BR2 NCV70516MW1	BR2G non wettable flank	2024-04-24 PHG		PHG	73.6	mg	Each	
Manufacturing Proccess Information									
Terminal Plating / Grid Array Material	Ferminal Base Alloy	J-STD-020 MSL Rating	Peak Process Body Temperat		ture Max Time at Peak	Temperature Nu	mber of Reflow Cy	cles	
Matte Tin (Sn) - annealed	Matte Tin (Sn) - annealed CU Alloy 1		260	С	30	seconds 3			
Comments									
evel 1 - maximum time at peak temperature during so	ldering is 10-30 seconds								
For more information regarding material composition	please refer to page 3								

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth					
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the				
Supplier Digital Signature Ra	stislav Drska	Le							

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.84	mg	Supplier	Silicon (Si)	7440-21-3		2.84	mg
Die Attach	1.5	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.09	mg
			Supplier	Silver (Ag)	7440-22-4		1.2225	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.09	mg
			Supplier	Misc.	Proprietary Data		0.0075	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.09	mg
Lead Frame 3	35.95	mg	Supplier	Zinc (Zn)	7440-66-6		0.0395	mg
			Supplier	Iron (Fe)	7439-89-6		0.8412	mg
			Supplier	Copper (Cu)	7440-50-8		35.0584	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0108	mg
Mold Compound-Black	32.45	mg	Supplier	Silica Amorphous (SiO2)	7631-86-9		2.596	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1622	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.649	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		25.4733	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		2.596	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.9735	mg
Plating	0.29	mg	Supplier	Tin (Sn)	7440-31-5		0.29	mg
Wire Bond - Au	0.57	mg	Supplier	Gold (Au)	7440-57-5		0.57	mg